



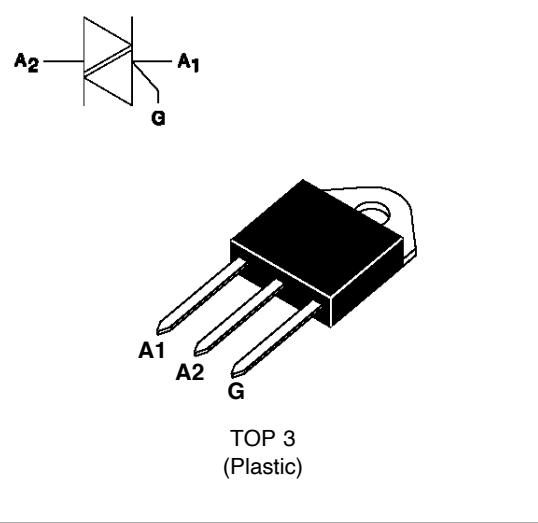
**SGS-THOMSON**  
MICROELECTRONICS

**BTA41 A/B**  
**BTB41 B**

## STANDARD TRIACS

### FEATURES

- HIGH SURGE CURRENT CAPABILITY
- COMMUTATION :  $(dV/dt)c > 10V/\mu s$
- BTA Family :
  - INSULATING VOLTAGE = 2500V<sub>(RMS)</sub>
  - (UL RECOGNIZED : E81734)



### DESCRIPTION

The BTA41 A/B / BTB41 B triac family are high performance glass passivated PNPN devices. These parts are suitable for general purpose applications where high surge current capability is required. Application such as phase control and static switching on inductive or resistive load.

### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
IT(RMS)	RMS on-state current (360° conduction angle)	BTA	Tc = 75 °C	40	A
		BTB	Tc = 85 °C	45	
ITSM	Non repetitive surge peak on-state current ( Tj initial = 25°C )		tp = 8.3 ms	315	A
			tp = 10 ms	300	
I2t	I2t value	tp = 10 ms	450	A2s	
dI/dt	Critical rate of rise of on-state current Gate supply : Ig = 500mA diG/dt = 1A/μs		Repetitive F = 50 Hz	10	A/μs
			Non Repetitive	50	
Tstg Tj	Storage and operating junction temperature range	- 40 to + 150 - 40 to + 125	°C °C		
Tl	Maximum lead temperature for soldering during 10 s at 4.5 mm from case	260		°C	

Symbol	Parameter	BTA41-...A/B / BTB41-... B				Unit
		400	600	700	800	
VDRM VRRM	Repetitive peak off-state voltage Tj = 125 °C	400	600	700	800	V

## BTA41 A/B / BTB41 B

### THERMAL RESISTANCES

Symbol	Parameter		Value		Unit
Rth (j-a)	Junction to ambient		50		°C/W
Rth (j-c) DC	Junction to case for DC		BTA	1.2	°C/W
	BTB	0.8			
Rth (j-c) AC	Junction to case for 360° conduction angle ( F= 50 Hz)		BTA	0.9	°C/W
	BTB	0.6			

### GATE CHARACTERISTICS (maximum values)

PG (AV) = 1W PGM = 40W (tp = 20 μs) IGM = 8A (tp = 20 μs) VGM = 16V (tp = 20 μs).

### ELECTRICAL CHARACTERISTICS

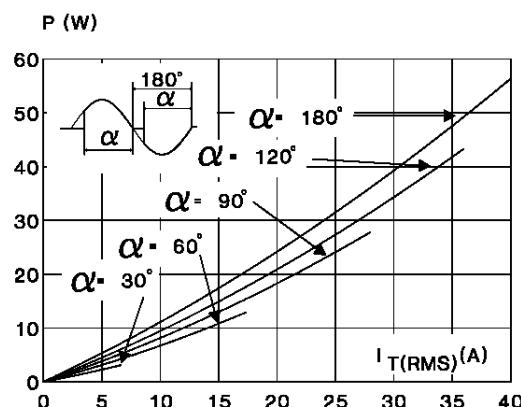
Symbol	Test Conditions	Quadrant		Suffix		Unit	
				A	B		
IGT	VD=12V (DC) RL=33Ω	Tj=25°C	I-II-III	MAX	100	mA	
			IV	MAX	150		
VGT	VD=12V (DC) RL=33Ω	Tj=25°C	I-II-III-IV	MAX	1.5		
VGD	VD=VDRM RL=3.3kΩ	Tj=125°C	I-II-III-IV	MIN	0.2		
tgt	VD=VDRM IG = 500mA dIG/dt = 3A/μs	Tj=25°C	I-II-III-IV	TYP	2.5		
IL	IG=1.2 IGT	Tj=25°C	I-III-IV	TYP	70	mA	
			II		200		
IH *	IT= 500mA gate open	Tj=25°C		MAX	100	mA	
VTM *	ITM= 60A tp= 380μs	Tj=25°C		MAX	1.8		
IDRM IRRM	VDRM Rated VRMM Rated	Tj=25°C		MAX	0.01		
		Tj=125°C		MAX	6		
dV/dt *	Linear slope up to VD=67%VDRM gate open	Tj=125°C		MIN	250	250	
(dV/dt)c *	(dI/dt)c = 18A/ms (dI/dt)c = 20A/ms	BTA BTB	Tj=125°C	MIN	10		

\* For either polarity of electrode A2 voltage with reference to electrode A1.

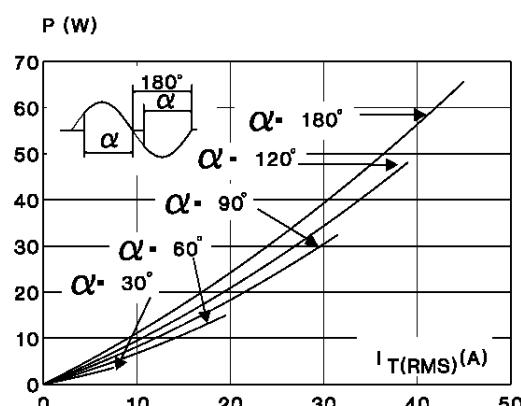
**ORDERING INFORMATION**

Package	$I_T(\text{RMS})$	$V_{\text{DRM}} / V_{\text{RRM}}$	Sensitivity Specification	
	A	V	A	B
BTA (Insulated)	41	400	X	X
		600	X	X
		700	X	X
		800	X	X
BTB (Uninsulated)	45	400		X
		600		X
		700		X
		800		X

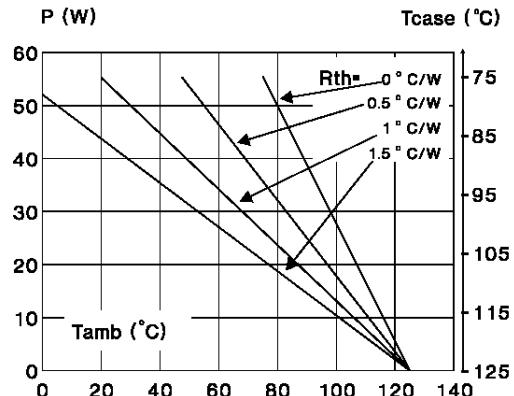
**Fig.1** : Maximum RMS power dissipation versus RMS on-state current ( $F=50\text{Hz}$ ).  
(Curves are cut off by  $(dI/dt)_c$  limitation) (BTA)



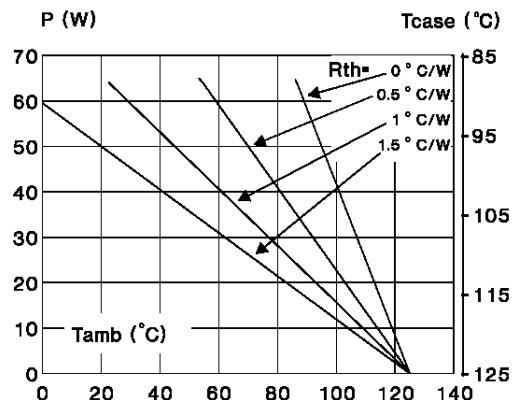
**Fig.3** : Maximum RMS power dissipation versus RMS on-state current ( $F=50\text{Hz}$ ).  
(Curves are cut off by  $(dI/dt)_c$  limitation) (BTB)



**Fig.2** : Correlation between maximum RMS power dissipation and maximum allowable temperatures ( $T_{\text{amb}}$  and  $T_{\text{case}}$ ) for different thermal resistances heatsink + contact (BTA).

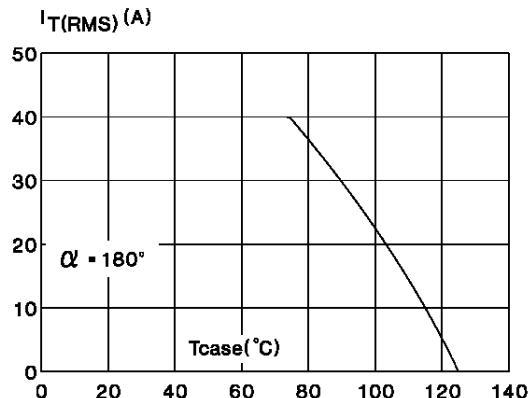


**Fig.4** : Correlation between maximum RMS power dissipation and maximum allowable temperatures ( $T_{\text{amb}}$  and  $T_{\text{case}}$ ) for different thermal resistances heatsink + contact (BTB).

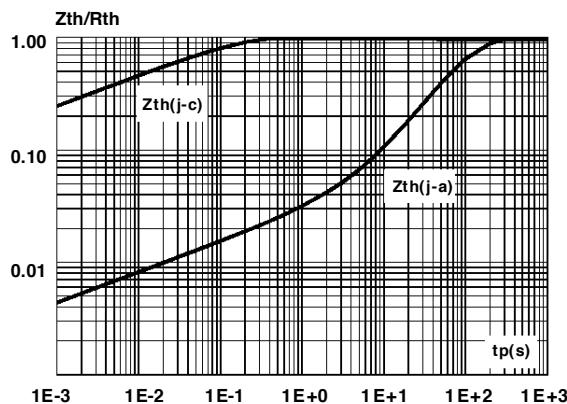


## BTA41 A/B / BTB41 B

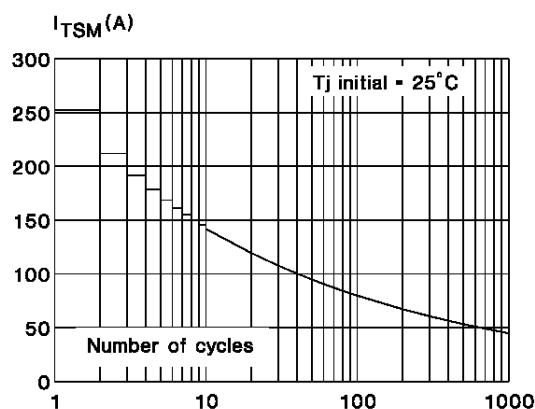
**Fig.5 :** RMS on-state current versus case temperature.  
(BTA)



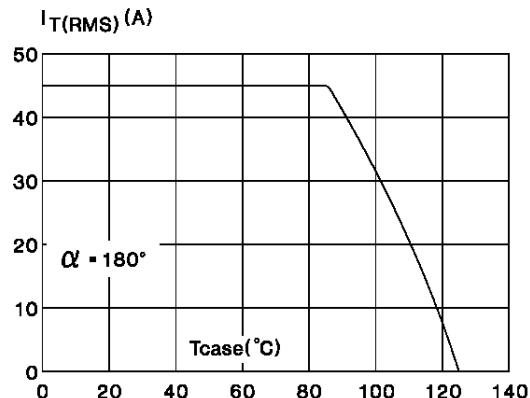
**Fig.7 :** Relative variation of thermal transient impedance pulse duration.



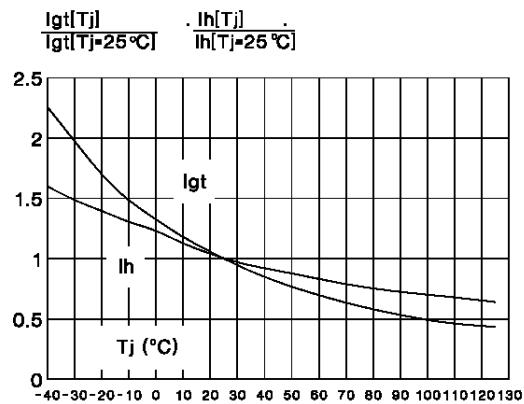
**Fig.9 :** Non Repetitive surge peak on-state current versus number of cycles.



**Fig.6 :** RMS on-state current versus case temperature.  
(BTB)



**Fig.8 :** Relative variation of gate trigger current and holding current versus junction temperature.



**Fig.10 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .

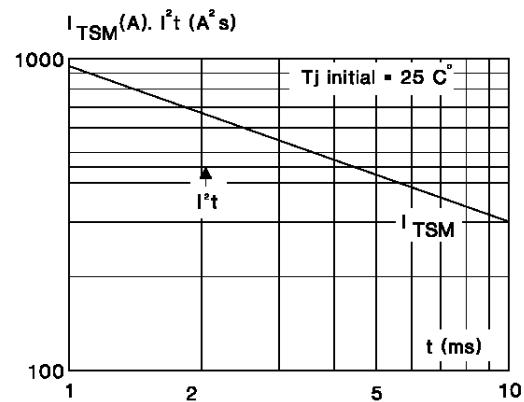
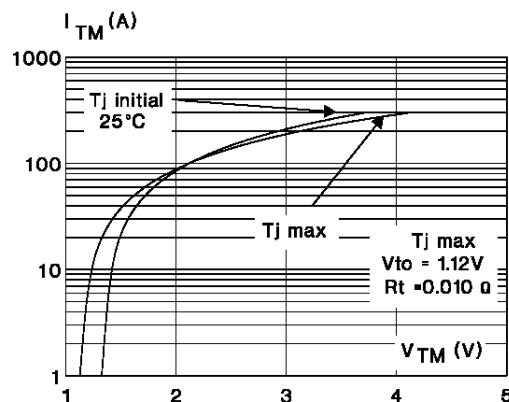


Fig.11 : On-state characteristics (maximum values).



## PACKAGE MECHANICAL DATA

TOP 3 Plastic

Detailed description: The mechanical drawing shows two views of the package. The left view is a top-down perspective showing lead spacing (P), lead thickness (N), lead height (D), lead width (G), lead pitch (A), lead length (I), and lead height (J). The right view is a side cross-section showing lead height (H), lead width (J), lead height (L), lead width (M), and lead height (C).

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	15.10	15.50	0.594	0.611
B	20.70	21.10	0.814	0.831
C	14.30	15.60	0.561	0.615
D	16.10	16.50	0.632	0.650
G	3.40	-	0.133	-
H	4.40	4.60	0.173	0.182
I	4.08	4.17	0.161	0.164
J	1.45	1.55	0.057	0.062
L	0.50	0.70	0.019	0.028
M	2.70	2.90	0.106	0.115
N	5.40	5.65	0.212	0.223
P	1.20	1.40	0.047	0.056

Cooling method : C

Marking : type number

Weight : 4.7 g

Recommended torque value : 0.8 m.N.

Maximum torque value : 1 m.N.

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